

General Description

The CMSA1402 uses advanced process technology and design to provide excellent RDS(ON).

This device is suitable for use as a Battery protection or in other Switching application.

Features

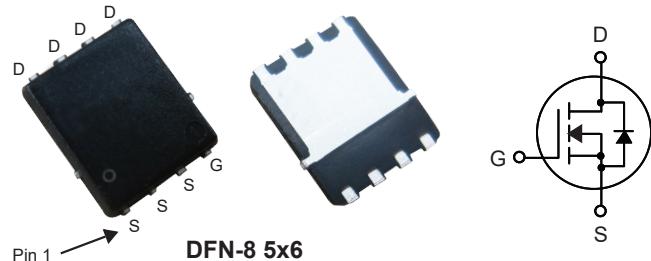
- Low On-Resistance
- 100% avalanche tested
- Simple Drive Requirements
- Surface Mount Package
- RoHS Compliant

Absolute Maximum Ratings**Product Summary**

BVDSS	R _{Ds(on)} max.	ID
20V	4.3mΩ	50A

Applications

- DC/DC Converters in Computing, Servers, and POL
- Battery protection switch

DFN-8 5x6 Pin Configuration

Type	Package	Marking
CMSA1402	DFN-8 5x6	CMSA1402

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	20	V
V _{GS}	Gate-Source Voltage	±12	V
I _D @T _c =25°C	Continuous Drain Current	50	A
I _D @T _c =100°C	Continuous Drain Current	35	A
I _{DM}	Pulsed Drain Current	200	A
EAS	Single Pulse Avalanche Energy ¹	115	mJ
P _D @T _c =25°C	Total Power Dissipation	50	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient	---	60	°C/W
R _{θJC}	Thermal Resistance Junction-case	---	2.5	°C/W

Electrical Characteristics (T_J=25°C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250μA	20	---	---	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =20A	---	3.7	4.3	mΩ
		V _{GS} = 4.5V, I _D =20A	---	4.1	5	
		V _{GS} = 2.5V, I _D =10A	---	5.4	7	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D = 250μA	0.5	---	1.5	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =20V , V _{GS} =0V	---	---	1	μA
I _{GSS}	Gate-Source Leakage Current	V _{GS} = ±12V	---	---	±100	nA
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =30A	---	42	---	S
Q _g	Total Gate Charge	V _{DD} =10V , I _D =20A V _{GS} =4.5V	---	31	---	nC
Q _{gs}	Gate-Source Charge		---	5.2	---	
Q _{gd}	Gate-Drain Charge		---	8	---	
T _{d(on)}	Turn-On Delay Time	V _{DD} =10V , V _{GS} =10V , R _{GEN} =3Ω R _L =0.5Ω	---	8	---	ns
T _r	Rise Time		---	15	---	
T _{d(off)}	Turn-Off Delay Time		---	72	---	
T _f	Fall Time		---	21	---	
C _{iss}	Input Capacitance	V _{DS} = 20V , V _{GS} =0V , f=1MHz	---	2200	---	pF
C _{oss}	Output Capacitance		---	310	---	
C _{rss}	Reverse Transfer Capacitance		---	250	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Diode continuous forward current	V _G =V _D =0V , Force Current	---	---	50	A
I _{S,pulse}	Diode pulse current		---	---	200	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _F =20A , T _J =25°C	---	0.85	1.2	V

Note :

1.The EAS data shows Max. rating . The test condition is V_{DD}=20V , V_{GS}=10V , L=0.5mH , I_{AS}=21.5A

This product has been designed and qualified for the consumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserves the right to improve product design ,functions and reliability without notice.

Typical Characteristics

